1-31-92

To the Honorable Commissioner of Patents a

03-07-2000



101283466

U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office Docket No.: N99139G-US

iginal documents or copy thereof.

1. Name of conveying party(ies): Seiichi Watarai Additional names of conveying party(ies) attached? yes I no 3. Nature of Conveyance Assignment Merger Security Agreement Change of Name Other Execution Date: January 21, 2000	2. Name and address of receiving party(ies): Name: NEC CORPORATION Internal Address: Street Address: 7-1, Shiba 5-chome, Minato-ku, City: Tokyo Country: Japan Additional name(s) & address(es) attached? yes
4. Application number(s) or patent number(s): Title: TRANSIENT CURRENT PRODUCING METHOD, TRANSIENT CURRENT PRODUCING CIRCUIT, RELATED SEMICONDUCTOR INTEGRATED CIRCUIT AND LOGICAL CIRCUIT If this document is being filed together with a new application, the execution date of the application is	
5. Name and address of party to whom correspondence concerning document should be mailed: C. Lamont Whitham, Esq. Whitham, Curtis & Whitham Reston International Center 11800 Sunrise Valley Drive Suite 900 Reston, Virginia 20191	6. Total number of applications and patents involved:
9. Statement and signature To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. C. Lamont Whitham Name of Person Signing Signature Total number of pages including cover sheet: 3	

03/06/2000 DNGUYEN 00000100 09492075

01 FC:581

(40.00 OP/

PATENT REEL: 010582 FRAME: 0285 PATENT OR DESIGN: SOLE OR JOINT

(U.S. and Foreign Rights)

ASSIGNMENT FOR UNFILED APPLICATION FOR UNITED STATES PATENT

(Sole or Joint Inventors)

WHEREAS:

FULL NAME(S) AND POST OFFICE ADDRESS(S) OF INVENTOR(S) (including country)

SEIICHI WATARAI of

c/o NEC Corporation, 7-1, shiba 5-chome,

Minato-ku, Tokyo, Japan

(hereinafter referred to as ASSIGNOR), have invented and own a certain invention entitled:

TITLE OF INVENTION

TRANSIENT CURRENT PRODUCING METHOD, TRANSIENT

CURRENT PRODUCING CIRCUIT,

RELATED SEMICONDUCTOR INTEGRATED CIRCUIT AND

LOGICAL CIRCUIT

for which application for Letters Patent of the United States has been executed on even date herewith,

WHEREAS: NEC Corporation
7-1, Shiba 5-chome, Minato-ku,

Tokyo, Japan

FULL NAME AND
ADDRESS (including country)
OF ASSIGNEE

(hereinafter referred to as ASSIGNEE), is desirous of acquiring the entire interest in, to and under said invention and in, to and under Letters Patent or similar legal protection to be obtained therefor in the United States and in any and all foreign countries.

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that in consideration of the payment by AS-SIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration, ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the full and exclusive right, title and interest to said invention in the United States and its territorial possessions and in all foreign countries and to all Letters Patent or similar legal protection in the United States and its territorial possessions and in any and all foreign countries to be obtained for said invention by said application or any continuation, division, renewal, substitute or reissue thereof or

(Assignment for Unfiled Application for United States Patent—page 1 of 2)

PATENT REEL: 010582 FRAME: 0286 any legal equivalent thereof in a foreign country for the full term or terms for which the same may be granted.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to ASSIGNOR and will testify as to the same in any interference or litigation related thereto and will promptly execute and deliver to ASSIGNEE or its legal representative any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof in any foreign country which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, I/We have hereunto set hand and seal this <u>January 21, 2000</u>

(Date of Signing)

Signature)

(Signature)

(Signature)

Witness:

All information, names of inventor(s) and assignee, title of invention and particulars of application should be completed.

No witnessing or legalization is necessary. However, if this assignment is legalized then it will only be prime facie evidence of the execution of the assignment.

(Assignment for Unfiled Application for United States Patent-page 2 of 2)

Instruction sheet for assignment Signing

Warning
DATE OF SIGNING:

or design application.

the inventor(s) above.

SIGNATURE(S)
The signature(s) must

This must be the same as the date of signing of the decla-

ration and power of the patent

correspond with the name(s) of

RECORDED: 01/27/2000

PATENT REEL: 010582 FRAME: 0287